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Low drop - Low supply voltage Low ESR capacitor compatible

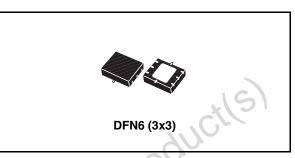
Feature summary

- Input voltage from 1.7 to 3.6V
- Ultra low dropout voltage (130mV typ. at 300mA load)
- Very low quiescent current (110µA typ. at no load, 130µA max. at 300mA load; max 0.5µA in OFF MODE)
- Output voltage tolerance: +/- 1.0% @ 25°C, +/-2.0% full temperature range
- Guaranteed output current up to 300mA
- Wide range of output voltage: 0.8V to 3.0V
- Logic-controlled electronic shutdown
- Compatible with ceramic capacitor $C_0 = 1\mu F$
- Internal current and thermal limit
- Temperature range: -40°C to 85°C

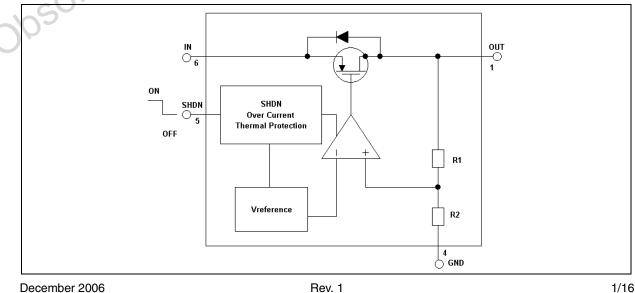
Description

The LD3980 provides up to 300mA, from 1.7V to 3.6V input voltage. It can deliver a guaranteed 300mA continuous load current with a low 100mV dropout. It is stable with ceramic capacitor. The

Block diagram



ultra low drop-voltage, low quiescent current and low noise makes it suitable for low power applications and in battery powered systems. High power supply rejection is maintained down to low input voltage levels common to battery operated circuits. Shutdown Logic Control function is available this means that when the device is used as local regulator, it is possible to put a part of the board in standby, decreasing the total power consumption. The device also includes a constant current limiting and thermal overload protection. Typical applications are in mobile phone, personal digital assistant (PDAs), cordless phone and similar battery powered wireless systems, portable information appliances ..





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Pin configuration

Pin configuration 1

Figure 1. **Pin connections**

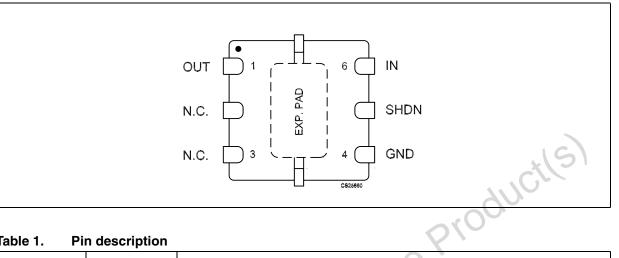


Table 1. **Pin description**

Pin N°	Symbol	Name and function
1	OUT	Output Voltage of the LDO
2, 3	NC	Not connected
4	GND	Common ground.
5	SHDN	SHUTDOWN Input Voltage: Active-Low Shutdown input. A logic Low reduces supply current to below 1µA. Connect to IN or logic high for normal operation
6	IN	Input Voltage of the LDO

Table 2. Thermal data

Symbol	Parameter	Value	Unit
R _{thJA}	Thermal resistance junction-ambient	55	°C/W
ipso'			





Maximum ratings

LD3980

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2 Maximum ratings

Table 3.	Absolute r	maximum	ratings
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Symbol	Parameter	Value	Unit
VI	DC Input voltage	-0.3 to 4.6	V
V _O	DC Output voltage	-0.3 to V ₁ +0.3	V
V _{SHDN}	Shutdown input voltage	-0.3 to V _I +0.3	V
V _{RESET}	Reset output voltage	-0.3 to V ₁ +0.3	V
Ι _Ο	Output current	Internally limited	mA
P _D	Power dissipation	Internally limited	mW
T _{STG}	Storage temperature range	-65 to 150	°C
T _{OP}	Operating junction temperature range	-40 to 85	°C

Note: Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these condition is not implied.

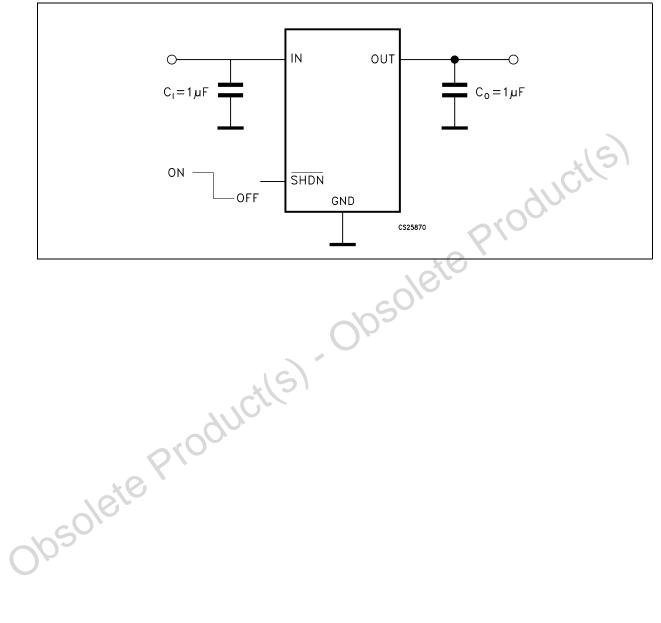


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Typical application

3 Typical application

Figure 2. Application circuit





Electrical characteristics

LD3980

4 Electrical characteristics

Table 4.	Electrical characteristics (T _J = 25°C, V _I = V _{O(NOM)} +0.5V, C _I = C _O = 1 μ F, I _O = 1mA,
	V _{SHDN} = V _I , unless otherwise specified) (<i>Note:</i> 1)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
VI	Operating input voltage		1.7		3.6	V	
V		I _O = 300mA	300mA -1.0		+1.0	%	
V _O	V _O Accuracy	$T_J = -40^\circ$ to 85° C	-2.0		+2.0	%	
ΔV_O	Line regulation	$V_{I} = V_{O} + 0.5V$ to 3.6V, $I_{O} = 1$ mA	-0.15	0.01	+0.15	%/V	
ΔV_O	Load regulation	I _O = 1mA to 300mA		0.2	0.3	%/mA	
V _{DROP}	Dropout voltage (Note 2)	$I_{O} = 300 \text{mA}, V_{O} \ge 1.8 \text{V}$ $T_{J} = -40^{\circ} \text{ to } 85^{\circ} \text{C}$		130	150	mV	
e _N	Output noise voltage	10Hz to 100KHz, I _O = 10mA,		110.7		μV _{RMS} /V _O	
SVR	Supply voltage rejection	$V_I = V_{O(NOM)}$ +0.5V $\pm V_{RIPPLE}$ $V_{RIPPLE} = 0.1V$, f = 1KHz, I _O = 10mA	2	60		dB	
SVN	(Figure 7.)	$V_{IN} = V_{O(NOM)}$ +0.5V±V _{RIPPLE} V _{RIPPLE} = 0.1V, f=10KHz, I _O = 10mA	, V	58		uв	
	Quiescent current ON MODE: V _{SHDN} =1.4V	I _O =0mA		90			
		$I_O=0mA$, $T_J = -40^\circ$ to 85° C			110	μΑ	
۱ _Q		I _O =0 to 300mA		105			
Q		I_{O} =0 to 300mA, T_{J} = -40° to 85°C			130	r	
	Quiescent current OFF MODE: V _{SHDN} =GND	V _I input current		0.15	0.5		
I _{SC}	Short circuit current	R _L =0		650		mA	
I _{O(PK)}	Peak output current	$V_O \ge V_{O(NOM)}$ -5%		610		mA	
M	Shutdown input logic low				0.4	v	
V _{SHDN}	Shutdown input logic high	$V_{I} = 1.6V$ to $3.6V T_{J} = -40^{\circ}$ to $85^{\circ}C$	1.4			v	
I _{SHDN}	Shutdown input current	V _{SHDN} =GND or V _I		0.1	100	nA	
T _{ON}	Turn on time	Note 3		120		μs	
T _{SHDN}	Thermal shutdown	Note 4		140		°C	
C	Output capacitor	Capacitance	1		10	μF	
CO		ESR	10		5000	mΩ	

Note: 1 *For* $V_{O(NOM)} < 1.2V$, $V_{l}=1.7V$

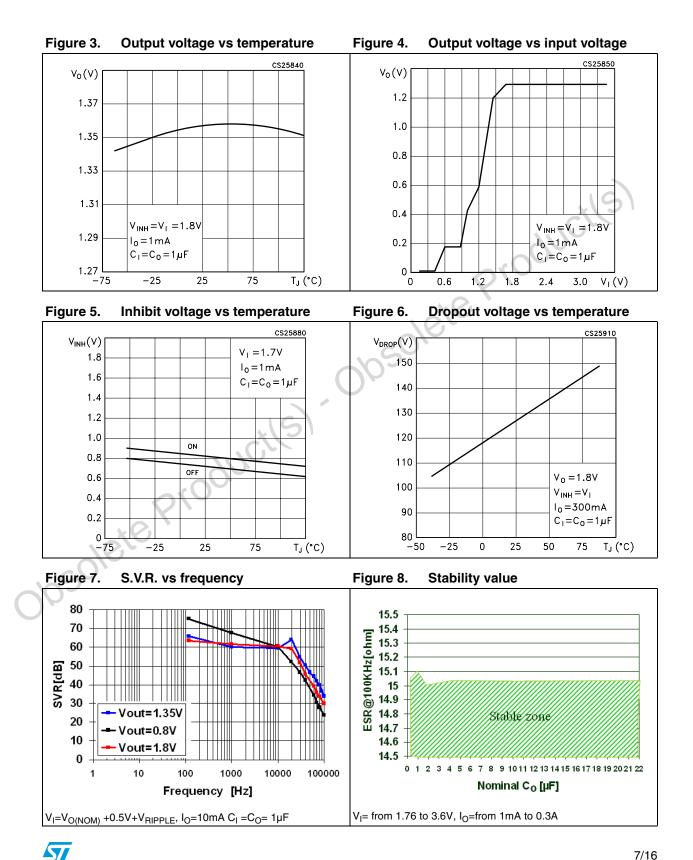
- 2 Dropout voltage is the input-to-output voltage difference at which the output voltage is 100mV below its nominal value. This specification does not apply for output voltages below 1.7V.
- 3 Turn-on time is time measured between the enable input just exceeding V_{SHDN} High Value and the output voltage just reaching 95% of its nominal value
- 4 Typical thermal protection hysteresis is 15°C.





Typical characteristics

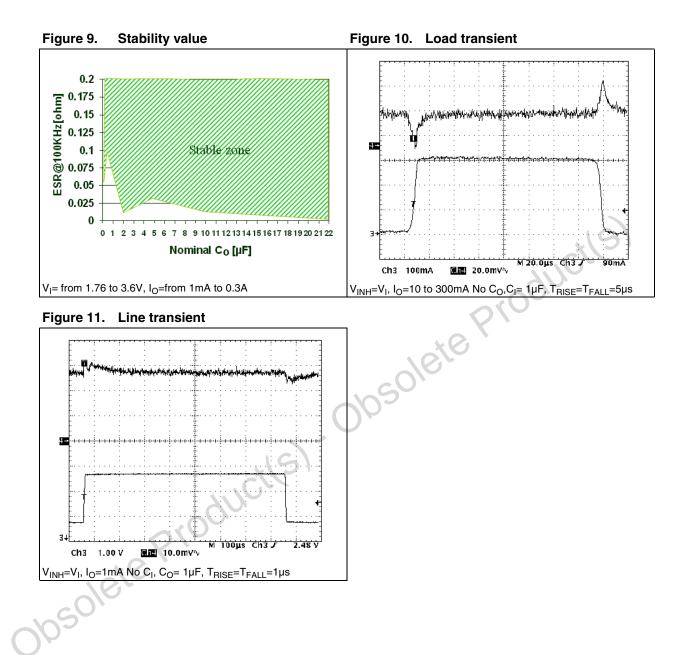
Typical characteristics 5





Typical characteristics

LD3980





Detailed description

6 Detailed description

The device is a low-dropout, low quiescent current linear regulator designed primarily for battery-powered applications. It supplies a regulated output voltage for load currents up to 300mA. The LD3980 consists of a precision bandgap, error amplifier, output p-channel MOS. The 0.7V bandgap reference is connected to the error amplifier. The error amplifier compares this reference to the feedback voltage and amplifies the difference. The MOSFET driver reads the error signal and applies the appropriate drive to the P-channel pass transistor. If the feedback voltage is lower than reference voltage, the pass transistor is pulled lower, allowing more current to pass and increasing the output voltage. If the feedback voltage is higher than the reference voltage, the pass transistor gate is driven higher, allowing less current to pass the output. The output voltage is feedback through an internal resistor voltage connected to OUT. Additional blocks include an output current limiter, a thermal sensor and shutdown logic.

6.1 Shutdown

Drive SHDN low to place the LD3980 in shutdown mode for DFN versions.

In shutdown mode, the pass transistor, control circuit, reference and all biases are turned off, reducing the supply current to typically 0.5µA. Connecting SHDN to IN every block is in normal operation.

6.2 Current limit

The device includes short-circuit protection. It includes a current limiter that controls the pass transistor's gate voltage to limit the output current to about 600mA.

6.3 Thermal overload protection

The Thermal over load protection limits total power dissipation in the device. When the junction temperature (T_J) exceeds +140°C, the thermal sensor sends a signal to the shutdown logic, turning off the pass transistor and allowing the device to cool. The pass transistor turns on again after the device's junction temperature typically cools by 15°C, resulting in a pulsed output during continuous thermal overload conditions.

6.4 Power dissipation

Maximum power dissipation of the LD3980 depends on the thermal resistance of the case and circuit board, the temperature difference between the die junction and ambient air, and the rate of air flow. The power dissipated by the device is:

 $\mathsf{P}_\mathsf{D} = \mathsf{I}_\mathsf{O} \left(\mathsf{V}_\mathsf{I} - \mathsf{V}_\mathsf{O} \right)$

The maximum power dissipation is:

 $P_{MAX} = (T_{JMAX} - T_A) / \theta_{JA}$ Where: $T_{JMAX} = +150^{\circ}C$





Detailed description

LD3980

T_A is the ambient temperature

 θ_{JA} thermal resistance.

The device's pins perform the dual function of providing an electrical connection as well as channeling heat away from the die. Use wide circuit-board traces and large, solid copper polygons to improve power dissipation. Using multiple vias to buried ground planes further enhances thermal conductivity.

6.5 Output capacitance

The device is specifically designed to employ ceramic output capacitors as low as 1µF. Ceramic capacitors below 10µF offer significant cost and space savings, along with high frequency noise filtering. Higher values and other types of capacitor may be used, but their equivalent series resistance should be maintained in the range of the table.



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LD3980

Package mechanical data

7 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK[®] packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

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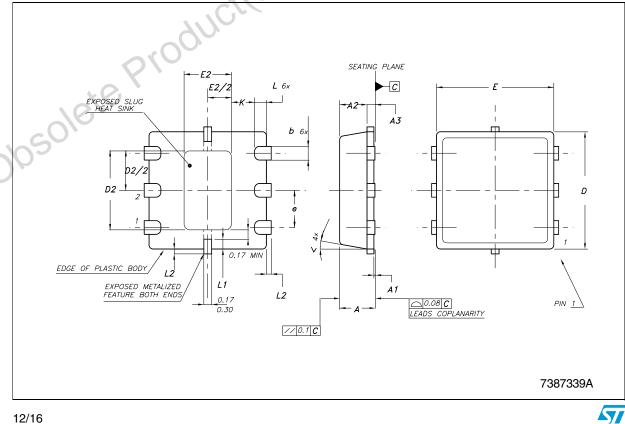




Package mechanical data

LD3980

DFN6 (3x3) MECHANICAL DATA						
DIM.		mm.			mils	
DIW.	MIN.	ТҮР	MAX.	MIN.	TYP.	MAX.
А	0.80		1.00	31.5		39.4
A1	0		0.05	0.0		2.0
A2	0.65		0.75	25.6		29.5
A3		0.20			7.9	
b	0.33		0.43	13.0		16.9
D	2.90	3.00	3.10	114.2	118.1	122.0
D2	1.92		2.12	75.6	00	83.5
E	2.90	3.00	3.10	114.2	118.1	122.0
E2	1.11		1.31	43.7		51.6
е		0.95		161	37.4	
L	0.20		0.45	7.9		17.7
L1		0.24	0.		9.4	
L2		-	0.13			5.1
К	0.20	16		7.9		

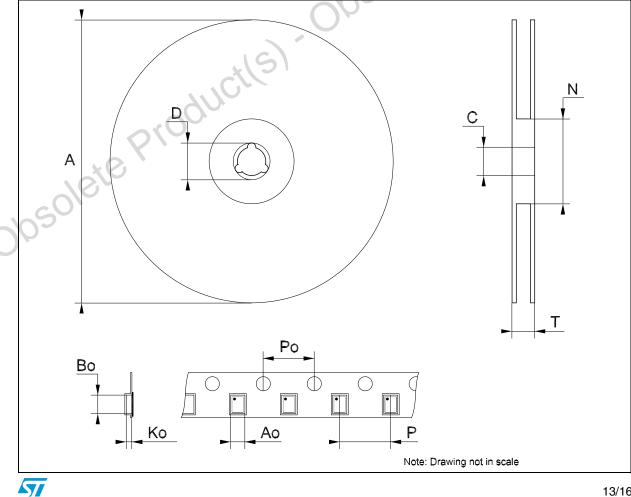




Package mechanical data

Tape & Reel QFNxx/DFNxx (3x3) MECHANICAL DATA

DIM.		mm.			inch	
DIWI.	MIN.	ТҮР	MAX.	MIN.	TYP.	MAX.
А			330			12.992
С	12.8		13.2	0.504		0.519
D	20.2			0.795		
Ν	60			2.362		
Т			18.4			0.724
Ao		3.3			0.130	
Во		3.3			0.130	
Ko		1.1			0.043	
Po		4		10 K	0.157	
Р		8		010	0.315	





Order code

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Order code 8

Table 5. Order code

	Output voltage ⁽¹⁾
LD3980PM08R	0.8 V
LD3980PM12R	1.2 V ⁽²⁾
LD3980PM13R	1.3 V ⁽²⁾
LD3980PM135R	1.35 V
LD3980PM15R	1.5 V ⁽²⁾
LD3980PM18R	1.8 V
LD3980PM30R	3.0 V ⁽²⁾
LD3980PM30R 1. Other values of V _O available on request 2. Available on request)psolete
CIL	



Revision history

9 Revision history

Table 6. Revision history

Date	Revision	Changes
05-Dec-2006	1	First release.

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